



PRELIMINARY

[查询'SDR705'供应商](#)

SOLID STATE DEVICES, INC

14849 Firestone Boulevard · La Mirada, CA 90638
Phone: (714) 670-SSDI (7734) · Fax: (714) 522-7424

**SDR705
thru
SDR720**

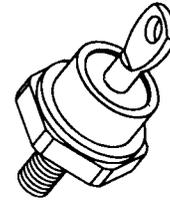
**70 AMP
50-200 VOLTS
50 nsec
ULTRA FAST
RECTIFIER**

Designer's Data Sheet

FEATURES:

- Ultra Fast Recovery: 50 nsec Maximum
- Low Forward Voltage Drop
- Low Reverse Leakage
- High Surge Current Capability
- Hermetically Sealed
- Single Chip Construction
- For High Efficiency Applications
- TX, TXV and Space Level Screening Available

DO-5



MAXIMUM RATINGS

RATING	SYMBOL	VALUE	UNIT
Peak Repetitive Reverse and DC Blocking Voltage	<p>SDR705 SDR710 SDR715 SDR720</p> <p>VRRM VRWM VR</p>	<p>50 100 150 200</p>	Volts
Average Rectified Forward Current (Resistive Load, 60Hz, Sine Wave, TA=25°C)	Io	70	Amps
Peak Surge Current (8.3 ms Pulse, Half Sine Wave, TA=25°C)	IFSM	750	Amps
Operating and storage temperature	Top & Tstg	-55 to +175	°C
Maximum Thermal Resistance Junction to Case	RθJC	1.0	°C/W

NOTE: All specifications are subject to change without notification.
SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: RU0057 A

RMD

SDR705

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SDR720

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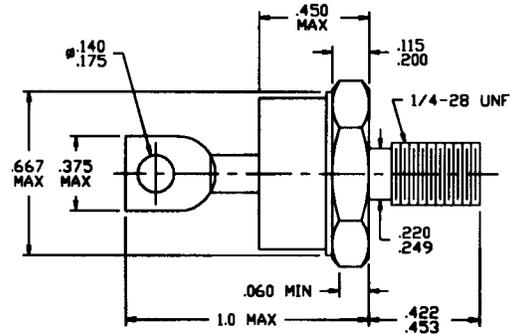
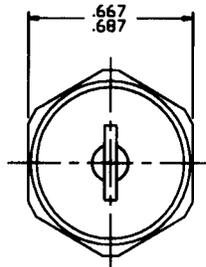
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ELECTRICAL CHARACTERISTICS

CHARACTERISTICS	SYMBOL	MAXIMUM	UNIT
Instantaneous Forward Voltage Drop ($I_F = 70 \text{ Adc}$, $T_A = 25^\circ\text{C}$, 300 μs Pulse)	VF	0.975	Vdc
Instantaneous Forward Voltage Drop ($I_F = 70 \text{ Adc}$, $T_A = -55^\circ\text{C}$, 300 μs Pulse)	VF	1.075	Vdc
Reverse Leakage Current (Rated V_R , $T_A = 25^\circ\text{C}$, 300 μs pulse minimum)	IR	25	μA
Reverse Leakage Current (Rated V_R , $T_A = 100^\circ\text{C}$, 300 μs pulse minimum)	IR	6	mA
Junction Capacitance ($V_R = 10 \text{ Vdc}$, $T_A = 25^\circ\text{C}$, $f = 1 \text{ MHz}$)	CJ	700	pf
Reverse Recovery Time ($I_F = 500\text{mA}$, $I_R = 1\text{A}$, $I_{RR} = 250\text{mA}$, $T_A = 25^\circ\text{C}$)	t _{rr}	50	nsec

CASE OUTLINE: DO-5



Dimensions prior to solder dipping.

TYPICAL OPERATING CURVES

$T_A = 25^\circ\text{C}$ Unless otherwise specified

